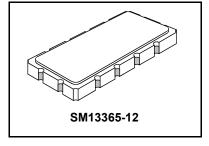




RFM products are now Murata products.

**SF2033A** 

# 350.00 MHz **SAW Filter**



### • Precision SAW Filter

- 13.3 x 6.5 mm Case
- Complies with Directive 2002/95/EC (RoHS)



#### **Maximum Rating**

Rating	Value	Units
Input Power Level	+20	dBm
Operating Temperature	-40 to +85	°C
Storage Temperature in Tape and Reel	-40 to +85 °C	
Suitable for Lead-free Soldering, Maximum Soldering Temperature	260 °C for 30 s	

#### **Electrical Characteristics**

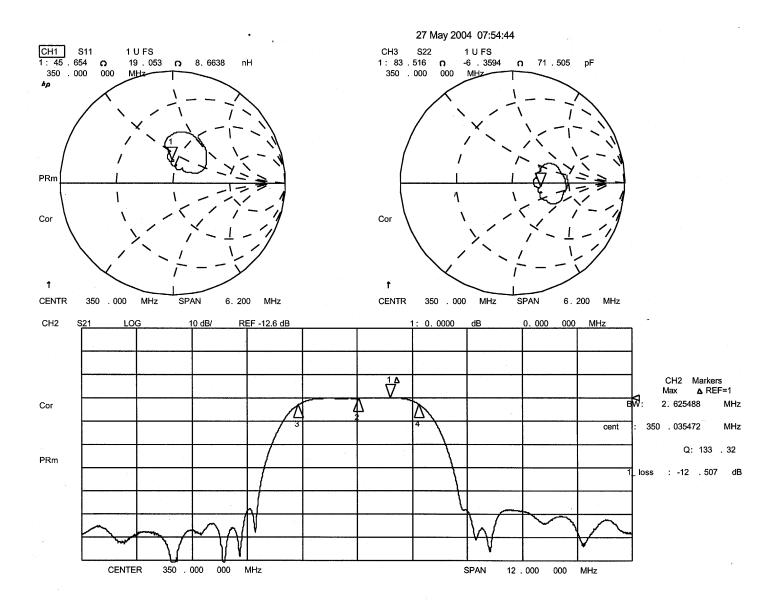
Characteristic	Sym	Notes	Min	Тур	Max	Units
Center Frequency	f <sub>C</sub>		349.9	350.0	350.1	MHz
Insertion Loss	IL			13.5	14.5	dB
3 dB Bandwidth			2.60	2.65		MHz
20 dB Bandwidth				3.8	4.0	MHz
45 dB Bandwidth				4.4	6.0	MHz
Amplitude Ripple, f <sub>C</sub> ± 0.85 MHz				0.4	0.7	dB
Group Delay Ripple, f <sub>C</sub> ± 1.1 MHz				35	70	ns
Substrate Material			Quartz			
Temperature Coefficient of Frequency				$\Delta F/F = -[(T-T_0)/5.4]^2$		ppm/K

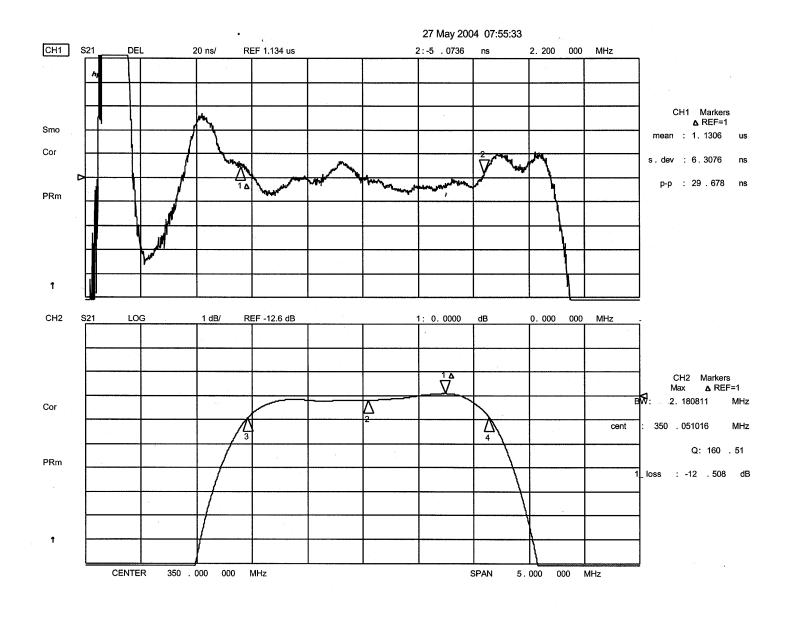
Case Style	SM13365-12 13.3 x 6.5 mm Nominal Footprint
Lid Symbolization	SF2033A
(YY=year, WW=week, S=shift, ##=sequence code) dot=pin 1 indicator	YYWWS##
Standard Reel Quantity Reel Size 7 Inch	500 Pieces/Reel
Reel Size 13 Inch	2000 Pieces/Reel

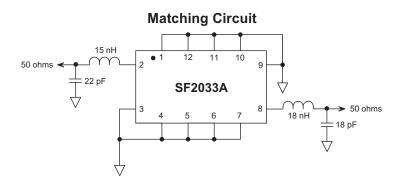
**CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.** 

#### NOTES:

US and International patents may apply. Murata, stylized Murata logo, and Murata N.A., Inc. are registered trademarks of Murata Manufacturing Co., Ltd.

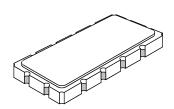






## SM13365-12 Case

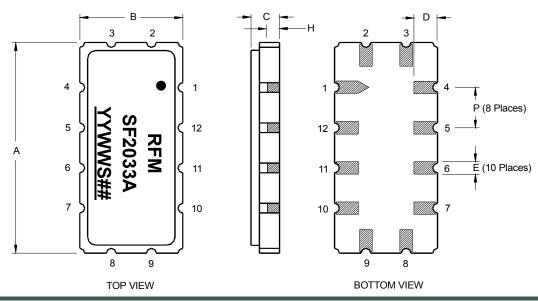
### 12-Terminal Ceramic Surface-Mount Case 13.3 x 6.5 mm Nominal Footprint



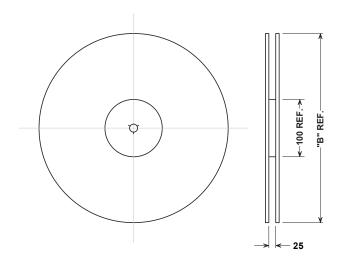
Case Dimensions						
Dimension	mm			Inc		
	Min	Nom	Max	Min	Nom	Max
Α	13.08	13.31	13.60	0.515	0.524	0.535
В	6.27	6.50	6.80	0.247	0.256	0.268
С		1.91	2.00		0.075	0.079
D		1.50			0.059	
E		0.79			0.031	
Н		1.0			0.039	
Р		2.54			0.100	

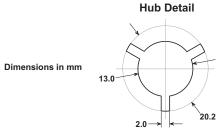
Electrical Connections				
	Connection	Terminals		
Port 1	Input or Return	2		
Port 2	Output or Return	8		
	Ground	All others		
Single-ended Operation		Return is ground		

Materials	
Solder Pad Plating	0.3 to 1.0 µm Gold over 1.27 to 8.89 µm Nickel
Lid Plating	2.0 to 3.0 µm Nickel
Body	Al <sub>2</sub> O <sub>3</sub> Ceramic
Pb Free	



### **Reel Dimensions**





## **Tape Dimensions**

